SDAS096C - JANUARY 1986 - REVISED JANUARY 1995

- Functionally Equivalent to AMD's AM29863
- Power-Up High-Impedance State
- Package Options Include Plastic Small-Outline (DW) Packages and Standard Plastic (NT) 300-mil DIPs

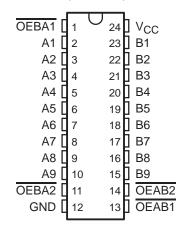
### description

This 9-bit transceiver is designed asynchronous two-way communication between data buses. The control-function implementation allows for maximum flexibility in timing.

This device allows data transmission from the A bus to the B bus or from the B bus to the A bus, depending on the logic levels at the output-enable (OEAB1, OEAB2, OEBA1, and OEBA2) inputs.

The SN74ALS29863 is characterized for operation from 0°C to 70°C.

#### **DW OR NT PACKAGE** (TOP VIEW)



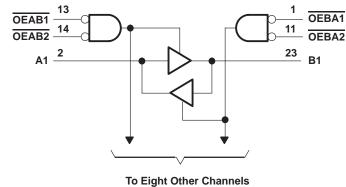
#### **FUNCTION TABLE**

	INP	UTS		ODEDATION
OEAB1	OEAB2	OEBA1	OEBA2	OPERATION
L	L	L	L	Latch A and B
L	L	Н	Χ	A 40 D
L	L	Χ	Н	A to B
Н	Χ	L	L	D ( - A
Х	Н	L	L	B to A
Н	Χ	Н	Χ	
Н	Χ	Χ	Н	Isolation
Х	Н	Χ	Н	isolation
Х	Н	Н	Χ	

## logic symbol†

#### & OEBA1 EN1 11 OEBA2 13 OEAB1 EN2 14 OEAB2 23 В1 **▽ 1** ◁ 2 ▽ 22 B2 Α2 21 4 А3 В3 5 20 **B**4 Α4 19 Α5 **B5** 7 18 **B6** A6 17 Α7 **B7** 16 **A8 B8** 15 В9 A9

### logic diagram (positive logic)



<sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage, V <sub>CC</sub>	 7 V
Input voltage, V <sub>I</sub> (all inputs and I/O ports)	 5.5 V
Operating free-air temperature range, TA	 0°C to 70°C
Storage temperature range	 -65°C to 150°C

<sup>‡</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

### recommended operating conditions

		MIN	NOM	MAX	UNIT
Vcc	Supply voltage	4.75	5	5.25	V
VIH	High-level input voltage	2			V
VIL	Low-level input voltage			8.0	V
lOH	High-level output current			-24	mA
l <sub>OL</sub>	Low-level output current			48	mA
TA	Operating free-air temperature	0		70	°C

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### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

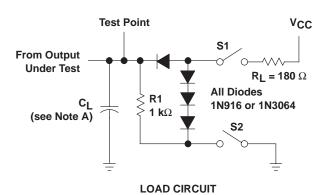
	PARAMETER	TEST CO	TEST CONDITIONS					
VIK		$V_{CC} = 4.75 V$ ,	$I_{I} = -18 \text{ mA}$			-1.2	V	
.,		I <sub>OH</sub> = -15 mA		2.4			.,	
VOH		$V_{CC} = 4.75 \text{ V}$	$I_{OH} = -24 \text{ mA}$	2			V	
VOL		$V_{CC} = 4.75 V$ ,	$I_{OL} = 48 \text{ mA}$		0.35	0.5	V	
Ц		$V_{CC} = 5.25 V$ ,	V <sub>I</sub> = 5.5 V			0.1	mA	
	Control inputs	V 505V	V 07V			20		
ΊΗ	A or B ports <sup>‡</sup>	$V_{CC} = 5.25 V$ ,	V <sub>I</sub> = 2.7 V			20	μΑ	
	Control inputs	V 505V	V 0.4V			-0.1		
ΊL	A or B ports <sup>‡</sup>	$V_{CC} = 5.25 V$ ,	$V_I = 0.4 V$			-0.1	mA	
los§		V <sub>CC</sub> = 5.25 V,	V <sub>O</sub> = 0	-75		-250	mA	
Icc		V <sub>CC</sub> = 5.25 V	_		40	65	mA	

### switching characteristics (see Figure 1)

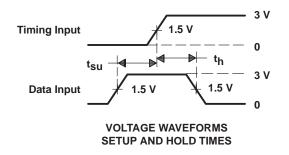
DARAMETER	FROM	то	TEGT COMPITIONS	V <sub>CC</sub> = 4.75 \	to 5.25 V		
PARAMETER	(INPUT)	(OUTPUT)	TEST CONDITIONS	MIN	MAX	UNIT	
t <sub>PLH</sub>	A - : : D	D A	0 000 = 5		15		
t <sub>PHL</sub>	A or B	B or A	C <sub>L</sub> = 300 pF		15	ns	
<sup>t</sup> PLH	A D	D A	0 50 5		8		
t <sub>PHL</sub>	A or B	B or A $C_L = 50 \text{ pF}$			8	ns	
<sup>t</sup> PZH	OFAD - OFDA				20		
tpZL	OEAB or OEBA	A or B	C <sub>L</sub> = 300 pF		23	ns	
<sup>t</sup> PZH	<u> </u>	. 5	0 50 5		15		
t <sub>PZL</sub>	OEAB or OEBA	A or B	$C_L = 50 pF$		15	ns	
<sup>t</sup> PHZ	OEAB or OEBA	A - : : D	0 50 5		17		
tpLZ	OEAB or OEBA	A or B	$C_L = 50 pF$		12	ns	
<sup>t</sup> PHZ	OEAB or OEBA	A or B	C: -5 pF		9	20	
t <sub>PLZ</sub>	OEAD UI OEBA	AUIB	$C_L = 5 pF$		9	ns	

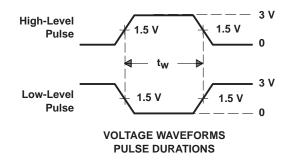
<sup>†</sup> All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C. ‡ For I/O ports, the parameters I<sub>IH</sub> and I<sub>IL</sub> include the off-state output current. § Not more than one output should be shorted at a time and duration of the short circuit should not exceed one second.

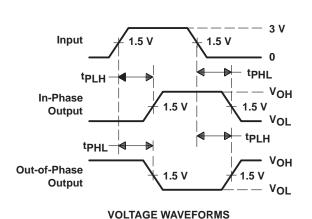
#### PARAMETER MEASUREMENT INFORMATION



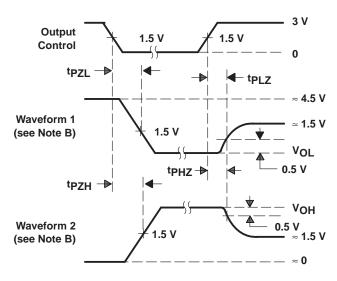
SWITCH POSITION TABLE								
TEST	S1	S2						
tPLH tPHL tPZH tPZL tPHZ tPHZ	Closed Closed Open Closed Closed Closed	Closed Closed Closed Open Closed Closed						







**PROPAGATION DELAY TIMES** 



**VOLTAGE WAVEFORMS ENABLE AND DISABLE TIMES, 3-STATE OUTPUTS** 

- NOTES: A. C<sub>L</sub> includes probe and jig capacitance.
  - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_O = 50 \,\Omega$ ,  $t_f \leq 2.5 \,$  ns.  $t_f \leq 2.5 \,$  ns.

Figure 1. Load Circuit and Voltage Waveforms



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#### PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
SN74ALS29863DW	ACTIVE	SOIC	DW	24	25	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS29863	Samples
SN74ALS29863DWE4	ACTIVE	SOIC	DW	24	25	TBD	Call TI	Call TI	0 to 70		Samples

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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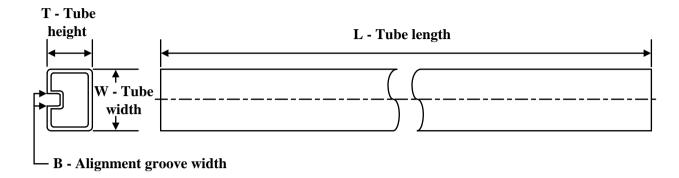
# **PACKAGE OPTION ADDENDUM**

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# **PACKAGE MATERIALS INFORMATION**

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### **TUBE**

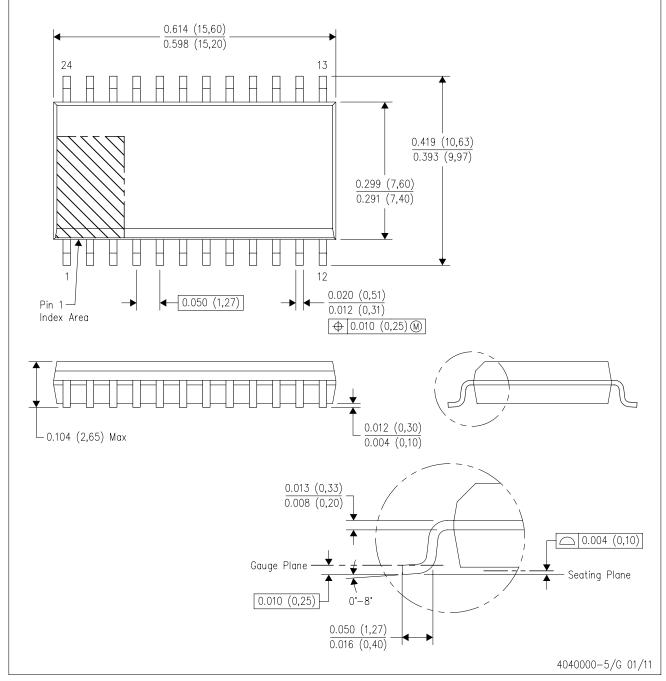


#### \*All dimensions are nominal

	Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
١	SN74ALS29863DW	DW	SOIC	24	25	506.98	12.7	4826	6.6

DW (R-PDSO-G24)

## PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in inches (millimeters). Dimensioning and tolerancing per ASME Y14.5M-1994.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-013 variation AD.



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